

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

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Title of Invention**DAMASCENE PATTERNING OF BARRIER LAYER METAL FOR C4 SOLDER BUMPS**

Application Number:

Confirmation Number:

First Named Applicant: Timothy Daubenspeck

Attorney Docket Number: BUR920040048US1

Search string: (6426556 or 6415974 or 6332988).pn.

US Patent Documents**Note: Applicant is not required to submit a paper copy of cited US Patent Documents**

| init | Cite.No. | Patent No. | Date | Patentee | Kind | Class | Subclass |
|------|----------|------------|------------|--------------------|------|-------|----------|
| | 1 | 6426556 | 2002-07-30 | Lin | | | |
| | 2 | 6415974 | 2002-07-09 | Jao | | | |
| | 3 | 6332988 | 2001-12-25 | Berger, Jr., et al | | | |

Signature

| Examiner Name | Date |
|---------------|------|
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